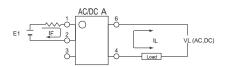
Parameter	Symbol	Rating	Units	
Load Voltage	VL	1800	V	
Load Current	lL .	0.030	Α	
Leakage Current	Leak	0.1	uA	
Low Out Capacitance	Cout	8	pF	





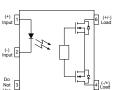












- $1. \ \ \mathsf{LED} \ \mathsf{Anode}$
- 2. LED Cathode
- 4. Drain (MOS FET)
- 6. Drain (MOS FET)

### **APSEMI PhotoRelays**

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power.

While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

### **Applications**

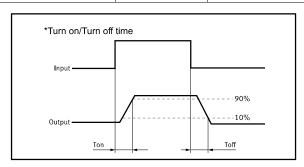
These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

#### **TPYES**

Cotogoni	Output Rating		Doolsono	Part No.	Poolsing Overtity	
Category Load Voltage Load Current		Package	Part No.	Packing Quantity		
AC/DC 1800V 30mA		20m A	DIP-5	APV278AE	50pcs /tube	
AC/DC 1800V	30mA	SMD-5	APV278AEH	1000pcs /reel		





# Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Va <b>l</b> ue	Units	Note	
	Continuous LED Current	ĪF	50	mA		
Input	Peak LED Current	<b>I</b> FP	1000	mA	f=100Hz, duty=1%	
	LED Reverse Voltage	VR	5	V		
	Input Power Dissipation	P <sub>In</sub>	75	mW		
	Load Voltage	V∟	1800	V(AC peak or DC)		
	Load Current	l.	30	mA		
Output	Peak Load Current	Peak	150	mA	100ms (1 pulse)	
	Output Power Dissipation	Pout	450	mW		
Total Power	Dissipation	Рт	500	mW		
I/O Breakdov	wn Vo <b>l</b> tage	V <sub>I/O</sub>	5000	Vrms	RH=60%, 1min	
Operating Te	emperature	Торг	-40 to 85	°C		
Storage Tem	perature	T <sub>stg</sub>	-40 to 100	°C		
Pin Soldering	g Temperature	Tsol	260	°C	10 sec max.	

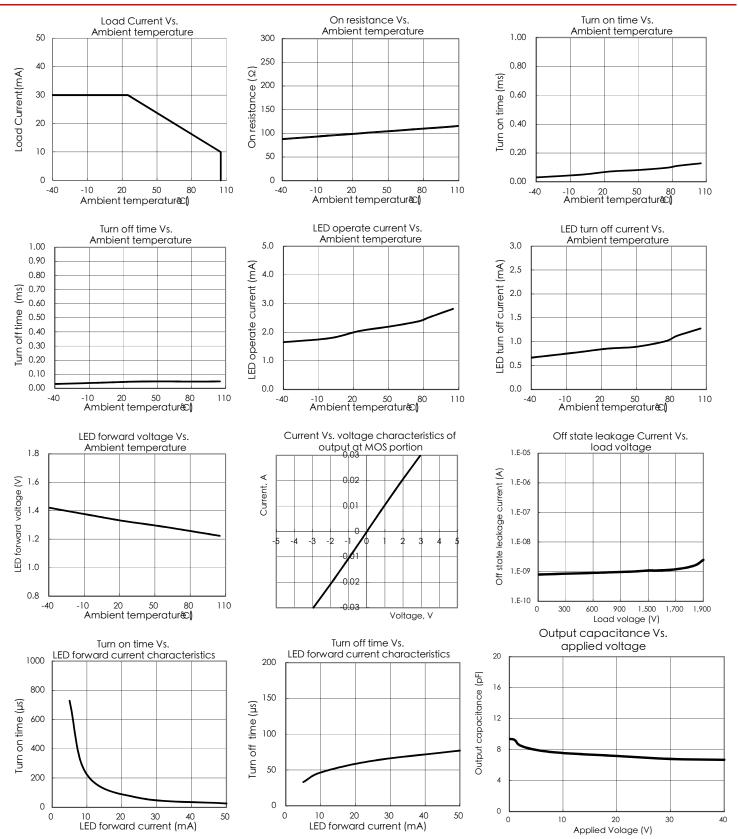
# Electrical Characteristics (Ta = 25°C)

	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions	
	LED Forward Voltage	VF		1.33	1.5	V	I⊧=10mA	
	Operation LED Current	Fon		1.0	2.0	mA		
Input	Recovery LED Current	Foff		0.35	0.8	mA		
	Recovery LED Voltage	V <sub>Foff</sub>	0.7			٧		
	On-Resistance	Ron	84	88	112	Ω	IF=10mA,IL= Rating, Time to flow is within 1 sec.	
Output	Off-State Leakage Current	Leak	0.01	0.03	0.10	uA	V∟=Rating	
	Output Capacitance	Cout		12		pF	V∟=0, f=1MHz	
Transmis	Turn-On Time	Ton		0.08	0.1	ms	IE 10 A L L D C	
sion	Turn-Off Time	Toff		0.05	0.1	ms	IF=10mA, I L=Rating	
0	I/O Isolation Resistance	R <sub>I/O</sub>	10 <sup>10</sup>			Ω	DC500V	
Coupled	I/O Capacitance	Cı/o		0.8	1.3	pF	f=1MHz	

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA



#### **Reference Data**

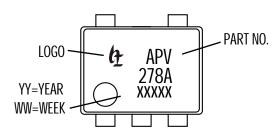




**Dimensions and DIP-5 Package** 

Unit: mm

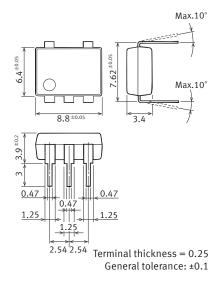
#### Marking



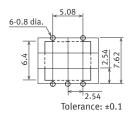
Lable



#### Through hole terminal type



# PC board pattern (Bottom view)



DIP Tape dimensions Unit: mm

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.

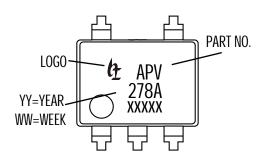




# **Dimensions and SMD-5 Package**

# Marking

Unit: mm

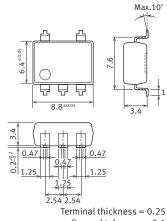


Lable



### Tape dimensions (tape reel)

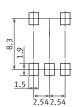
#### Surface mount terminal type



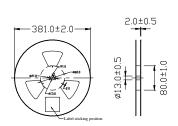
General tolerance: ±0.1

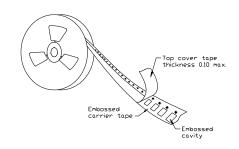
## Recommended mounting pad

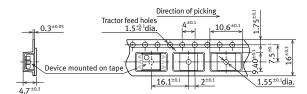
(Top view)



Tolerance: ±0.1



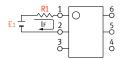


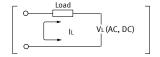




### **Using Methods**

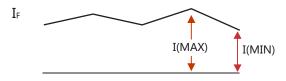
Examples of resistance value to control LED forward current (IF=5mA)





E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



#### **Recommended Operating Conditions**

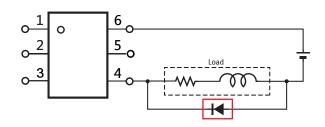
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

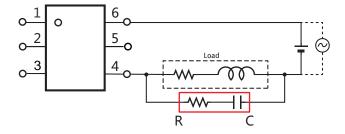
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

#### **Protection Circuit**

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



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